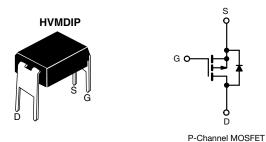




# **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-60				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = -10 V 0.28				
Q <sub>g</sub> max. (nC)	19				
Q <sub>gs</sub> (nC)	5.4				
Q <sub>gd</sub> (nC)	11				
Configuration	Single				



#### **FEATURES**

- Dynamic dV/dt rating
- Repetitive avalanche rated
- · For automatic insertion
- End stackable
- P-channel
- 175 °C operating temperature
- Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### DESCRIPTION

Third generation power MOSFETs from Vishay provides the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-Free	IRFD9020PbF

<b>ABSOLUTE MAXIMUM RATINGS</b> (TA	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	-60	V	
Gate-Source Voltage			V <sub>GS</sub>	± 20	V	
Continuous Drain Current	V <sub>GS</sub> at -10 V	T <sub>A</sub> = 25 °C	1-	-1.6		
Continuous Drain Current	$v_{GS}$ at -10 V	T <sub>A</sub> = 100 °C	- I <sub>D</sub>	-1.1	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	-13		
Linear Derating Factor				0.0083	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	140	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub> -1.6		А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	0.13	mJ	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C		PD	1.3	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	-4.5	V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175			
Soldering Recommendations (Peak temperature) <sup>d</sup>	For	10 s		300	- °C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

- b.  $V_{DD}$  = -25 V, starting T<sub>J</sub> = 25 °C, L = 15 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = -3.2 A (see fig. 12).
- c.  $I_{SD} \leq -11$  A, dI/dt  $\leq -140$  A/ms,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 175$  °C.

d. 1.6 mm from case.





THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP.		MAX.			UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		120	120		°C/W		
		ing method)							
<b>SPECIFICATIONS</b> ( $T_J = 25 \text{ °C}$ , u									
PARAMETER	SYMBOL	TEST	CONDITI	JNS	MIN.	TYP.	MAX.	UNI	
Static									
Drain-Source Breakdown Voltage	V <sub>DS</sub>		V, I <sub>D</sub> = - 2	-	-60	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference t			-	- 0.056	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	-	$V_{GS}, I_D = $	-	-2.0	-	-4.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	V	$G_{\rm GS} = \pm 20$		-	-	± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -	60 V, V <sub>GS</sub>	= 0 V	-	-	- 100	μA	
	<b>1</b> 055	V <sub>DS</sub> = -48 V, V	$_{\rm S}$ = -48 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C		-	-	- 500 <sup>µ</sup>	μι	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = -10 V$	I <sub>D</sub> :	= - 0.96 A <sup>b</sup>	-	-	0.28	Ω	
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> = -25	5 V, I <sub>D</sub> = -	0.96 A <sup>b</sup>	1.3	-	-	S	
Dynamic		·							
Input Capacitance	C <sub>iss</sub>	N 0 Y		-	570	-	pF		
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V, V_{DS} = -25 V, f = 1.0 MHz, see fig. 5$			-	360		-	
Reverse Transfer Capacitance	C <sub>rss</sub>				-	65		-	
Total Gate Charge	Qg				-	-	19		
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = -10 V$ $I_D = -11 A, V_{DS} = -48 V,$		-	-	5.4	nC		
Gate-Drain Charge	Q <sub>gd</sub>	1	see fig. 6 and 13 <sup>b</sup>		-	-	11	1	
Turn-On Delay Time	t <sub>d(on)</sub>				-	13	-		
Rise Time	t <sub>r</sub>	$\begin{tabular}{ c c c c c } & & & & & & & & & & & & & & & & & & &$		-	68	-	-		
Turn-Off Delay Time	t <sub>d(off)</sub>			15	-	ns			
Fall Time	t <sub>f</sub>	1	· · · · · · · · · · · · · · · · · · ·		-	29	-	1	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	- nH		
Internal Source Inductance	L <sub>S</sub>			-	6.0	-			
Drain-Source Body Diode Characteristic	s								
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 1.6	A		
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	- 13			
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I <sub>S</sub>	; = -1.6 A,	$V_{GS}$ = 0 V <sup>b</sup>	-	-	- 6.3	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = - 11A, di/dt = 100 A/μs <sup>b</sup>		-	100	200	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$I_{J} = 23 \text{ U}, I_{F} =$	- 11A, ul/	uι = 100 Α/μs <sup>.0</sup>	-	0.32	0.64	μC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn	-on time is	s negligible (turn	-on is do	minated b	y L <sub>S</sub> and	L <sub>D</sub> )	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

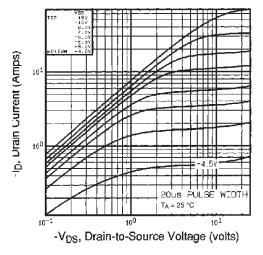


Fig. 1 - Typical Output Characteristics, T<sub>A</sub> = 25 °C

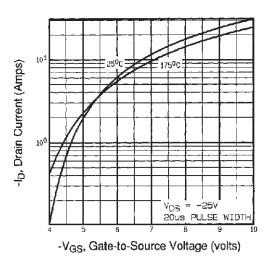


Fig. 3 - Typical Transfer Characteristics

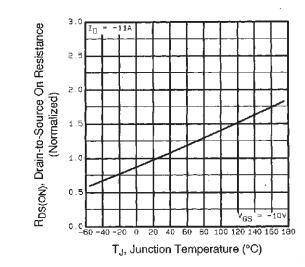


Fig. 4 - Normalized On-Resistance vs. Temperature

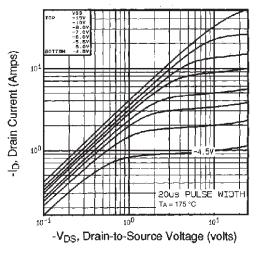


Fig. 2 - Typical Output Characteristics, T<sub>A</sub> = 175 °C



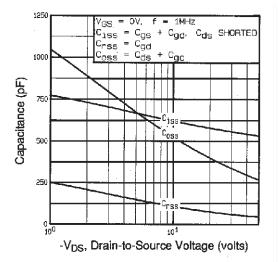


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

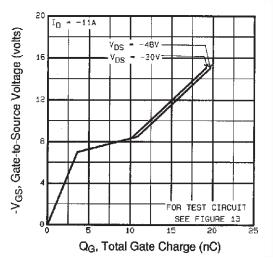
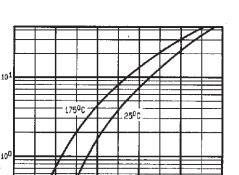
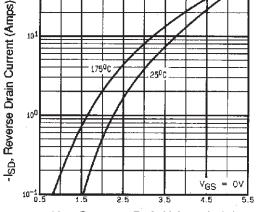


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage





-VSD, Source-to-Drain Voltage (volts)

Fig. 7 - Typical Source-Drain Diode Forward Voltage

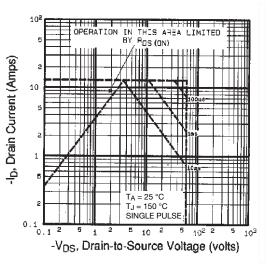


Fig. 8 - Maximum Safe Operating Area

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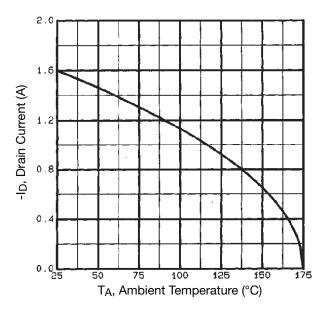


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

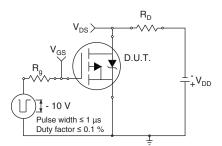


Fig. 10a - Switching Time Test Circuit

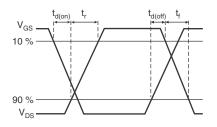
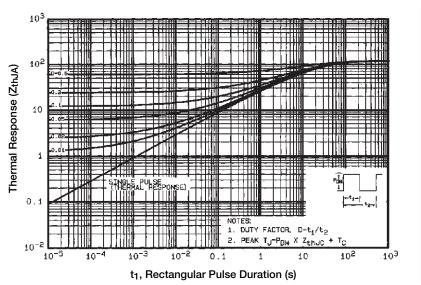


Fig. 10b - Switching Time Waveforms





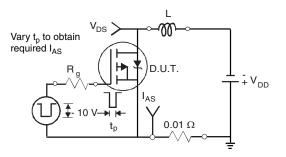
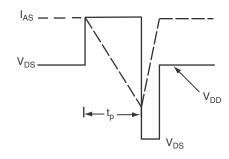
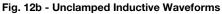


Fig. 12a - Unclamped Inductive Test Circuit





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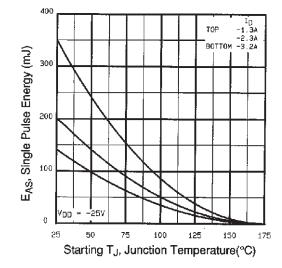


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

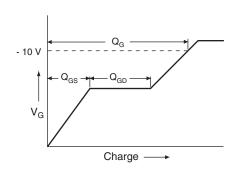


Fig. 13a - Basic Gate Charge Waveform

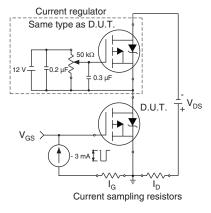


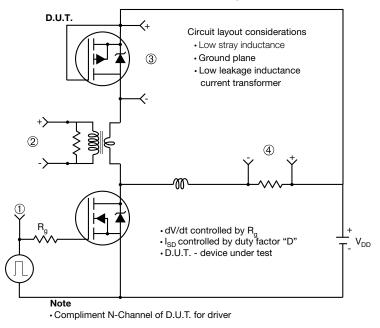
Fig. 13b - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit



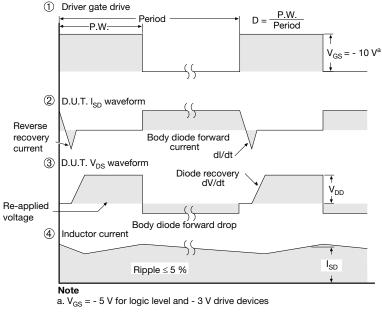


Fig. 14 - For P-Channel

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#### HVM DIP (High voltage)





	INCHES		MILLIN	IETERS
DIM.	MIN.	MAX.	MIN.	MAX.
А	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36
ECN: X10-0386-Rev. B, 0 DWG: 5974	06-Sep-10			

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.



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